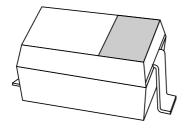
DISCRETE SEMICONDUCTORS

DATA SHEET



BAS316 High-speed diode

Product specification Supersedes data of 1998 Mar 26 2004 Feb 04





High-speed diode

BAS316

FEATURES

- · Very small plastic SMD package
- High switching speed: max. 4 ns
- Continuous reverse voltage: max. 100 V
- Repetitive peak reverse voltage: max. 100 V
- Repetitive peak forward current: max. 500 mA.

APPLICATIONS

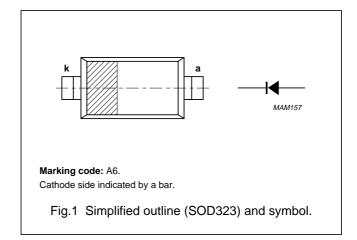
• High-speed switching in e.g. surface mounted circuits.

DESCRIPTION

The BAS316 is a high-speed switching diode fabricated in planar technology, and encapsulated in the SOD323 SMD plastic package.

PINNING

PIN	DESCRIPTION
1	cathode
2	anode



ORDERING INFORMATION

TYPE		PACKAGE	
NUMBER	NAME	DESCRIPTION	VERSION
BAS316	_	plastic surface mounted package; 2 leads	SOD323

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{RRM}	repetitive peak reverse voltage		_	100	V
V _R	continuous reverse voltage		_	100	V
I _F	continuous forward current	T _s = 90 °C; note 1; see Fig.2	_	250	mA
I _{FRM}	repetitive peak forward current		_	500	mA
I _{FSM}	non-repetitive peak forward current	square wave; $T_j = 25$ °C prior to surge; see Fig.4			
		t = 1 μs	_	4	Α
		t = 1 ms	_	1	Α
		t = 1 s	_	0.5	Α
P _{tot}	total power dissipation	T _s = 90 °C; note 1	_	400	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C

Note

1. T_s is the temperature at the soldering point of the cathode tab.

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CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V _F	forward voltage	see Fig.3		
		$I_F = 1 \text{ mA}$	715	mV
		$I_F = 10 \text{ mA}$	855	mV
		$I_F = 50 \text{ mA}$	1	V
		I _F = 150 mA	1.25	V
I _R	reverse current	see Fig.5		
		$V_{R} = 25 \text{ V}$	30	nA
		V _R = 75 V	1	μΑ
		$V_R = 25 \text{ V}; T_j = 150 ^{\circ}\text{C}$	30	μΑ
		V _R = 75 V; T _j = 150 °C	50	μΑ
C _d	diode capacitance	f = 1 MHz; V _R = 0; see Fig.6	1.5	pF
t _{rr}	reverse recovery time	when switched from I_F = 10 mA to I_R = 10 mA; R_L = 100 Ω ; measured at I_R = 1 mA; see Fig.7	4	ns
V _{fr}	forward recovery voltage	when switched from $I_F = 10$ mA; $t_r = 20$ ns; see Fig.8		V

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-s)}	thermal resistance from junction to soldering point	note 1	150	K/W

Note

1. Soldering point of the cathode tab.

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GRAPHICAL DATA

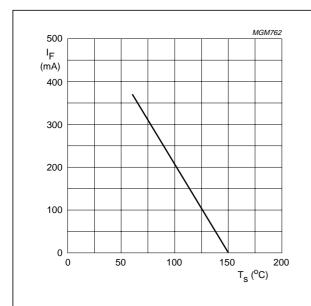
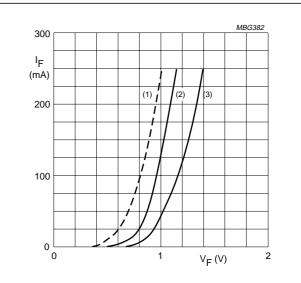
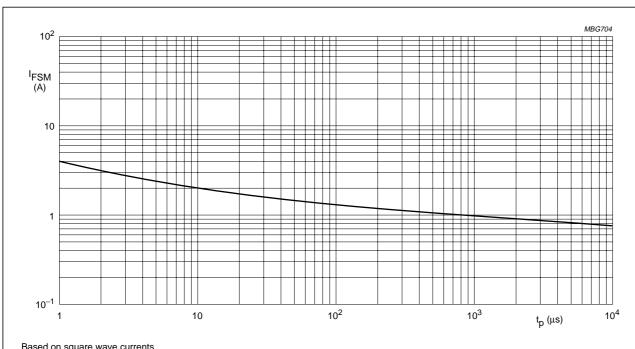


Fig.2 Maximum permissible continuous forward current as a function of soldering point temperature.



- (1) $T_j = 150$ °C; typical values.
- (2) $T_i = 25$ °C; typical values.
- (3) T_i = 25 °C; maximum values.

Fig.3 Forward current as a function of forward voltage.



Based on square wave currents.

 $T_j = 25$ °C prior to surge.

Fig.4 Maximum permissible non-repetitive peak forward current as a function of pulse duration.

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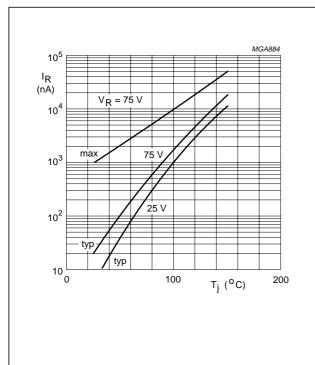


Fig.5 Reverse current as a function of junction temperature.

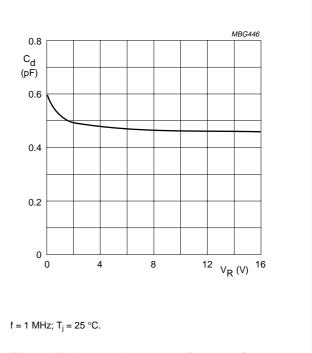
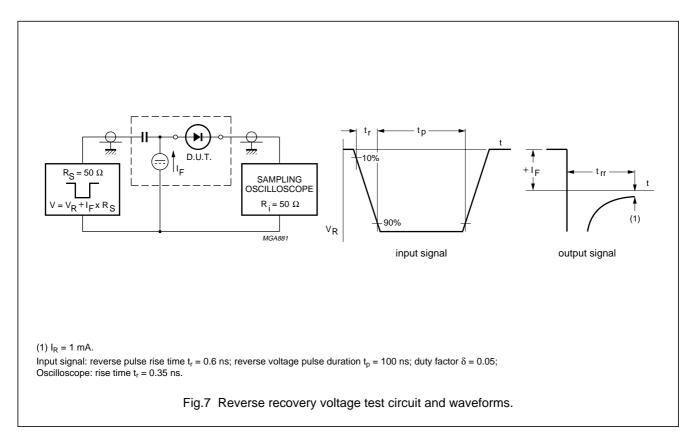
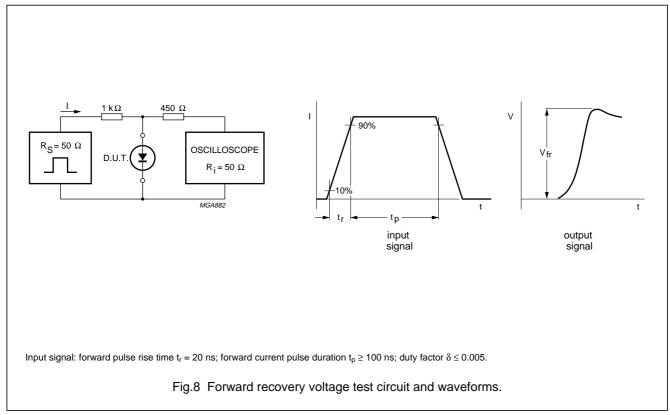


Fig.6 Diode capacitance as a function of reverse voltage; typical values.

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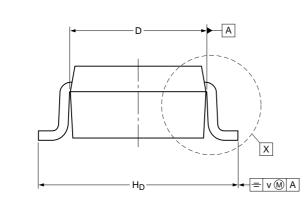
High-speed diode

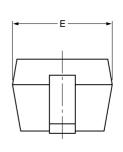
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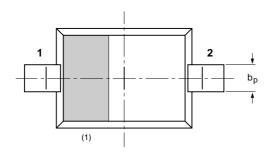
PACKAGE OUTLINE

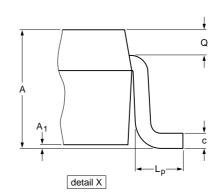


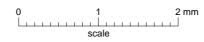
SOD323











DIMENSIONS (mm are the original dimensions)

UNIT	Α	A ₁ max	bp	С	D	E	H _D	Lp	Q	v
mm	1.1 0.8	0.05	0.40 0.25	0.25 0.10	1.8 1.6	1.35 1.15	2.7 2.3	0.45 0.15	0.25 0.15	0.2

Note
1. The marking bar indicates the cathode

OUTLINE						ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOD323			SC-76			99 09-13 03-12-17	

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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